

Features

- Low Clamping Voltage
- Typical 9V at 10A 100ns, TLP
- Typical 9V at 10A 8µs/20µs
- IEC 61000-4-2 (ESD): Air ±30kV, Contact ±30kV
- IEC 61000-4-4 (EFT): 60A (5/50ns, I/O to V_{SS})
- IEC 61000-4-5 (Lightning): ±10A
- 4 Channels of ESD Protection
- Low Channel Input Capacitance of 1.2pF Typical
- TLP Dynamic Resistance: 0.25Ω
- Typically Used for High Speed Ports such as USB 2.0, IEEE 1394, LVDS, Ethernet 10/100M/1000M BASE-T Flat Panel Displays, Video Graphics Displays, SIM Ports
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) .
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DT2042-04SOQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

SOT26





DT2042-04SOQ

4-CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

Mechanical Data

- Package: SOT26
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.016 grams (Approximate)

I/O 3

200			
47	1 I/O 1	2 V _{SS}	3 I/O 2
Top View	Devie	ce Sche	matic

Ordering Information (Note 4)

Part Number	Baakaga	Marking Deal Size (inches)		Tape Width (mm)	Packing	
Part Number	Package	Marking	Reel Size (inches)	Tape width (mm)	Qty.	Carrier
DT2042-04SOQ-7	SOT26	BC5	7	8	3,000	Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

I/O 4

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3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

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BC5 = Product Type Marking Code YM = Date Code Marking \overline{Y} = Year (ex: K = 2023) M = Month (ex: 9 = September)

Date Code Kev

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	К	L	М	Ν	Р	R	S	Т	U	V	W	Х
Year	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current, per IEC 61000-4-5	IPP	±10	A	I/O to Vss, 8/20 µs
Peak Pulse Power, per IEC 61000-4-5	Ppp	105	W	I/O to Vss, 8/20 µs
Operating Voltage (DC)	V _{DC}	5.5	V	I/O to V _{SS}
ESD Protection – Contact Discharge, per IEC61000-4-2	VESD_contact	±30	kV	I/O to Vss
ESD Protection – Air Discharge, per IEC 61000-4-2	VESD_air	±30	kV	I/O to Vss
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C	—

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation Typical (Note 5)	PD	300	mW
Thermal Resistance, Junction to Ambient Typical (Note 5)	Reja	417	°C/W

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

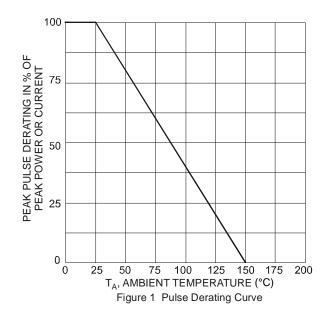
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V _{RWM}	—		5.5	V	I/O to V _{SS}
Reverse Current (Note 6)	I _R	—	_	1	μA	$V_R = 5V$, any I/O to V_{SS}
Reverse Breakdown Voltage	VBR	6	_	9	V	I _R = 1mA, I/O to V _{SS}
Forward Clamping Voltage	VF	-1.0	-0.8	—	V	IF = -15mA, I/O to Vss
Holding Voltage	VH	5.5	_	_	V	—
Trigger Voltage	V _{TRIG}	—	9	9.5	V	—
Reverse Clamping Voltage (Note 7)	Vc_5A	—	7.5	—	V	IPP = 5A, I/O to Vss, 8/20 μs
Reverse Clamping Voltage (Note 7)	Vc_10A	—	9	10.5	V	IPP = 10A, I/O to Vss, 8/20 µs
ESD Clamping Voltage (Note 8)	Vesd	_	9	_	V	TLP, 10A, tp = 100ns, I/O to Vss, per Figure 7
Dynamic Resistance (Note 8)	RDIF	—	0.25	_	Ω	TLP, 10A, tp = 100ns, I/O to Vss
Channel Input Capacitance	Ci/o	—	1.2	1.5	pF	V _R = 2.5V, f = 1MHz

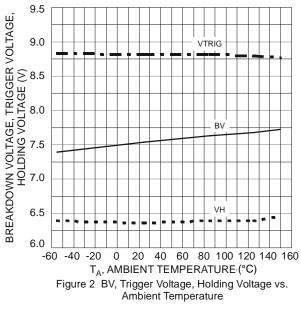
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com.

6. Short duration pulse test used to minimize self-heating effect.

7. Clamping voltage value is based on an $8x20\mu s$ peak pulse current (Ipp) waveform.

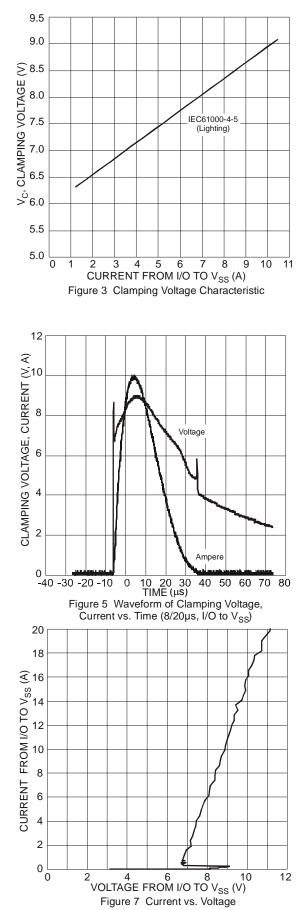
8. Transmission Line Pulse (TLP) test settings: t_P = 100ns, t_R = 10ns, I_{TLP} and V_{TLP} averaging window is from 70ns to 90ns.

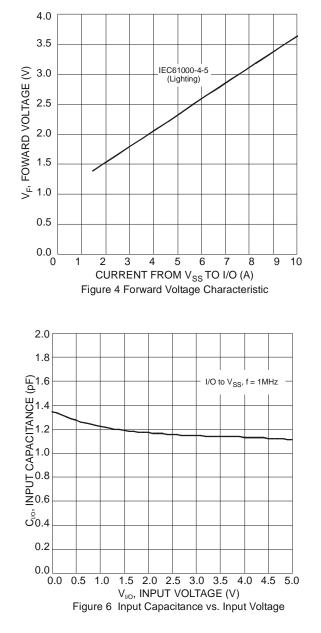






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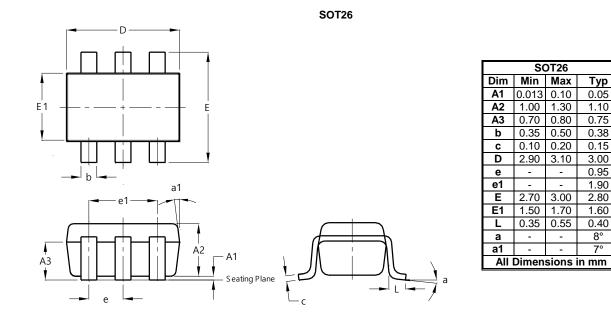






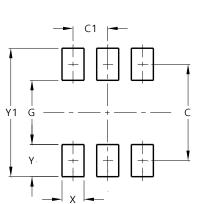
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT26

Dimensions	Value (in mm)
С	2.40
C1	0.95
G	1.60
Х	0.55
Y	0.80
Y1	3.20

DT2042-04SOQ Document number: DS45458 Rev. 1 - 2



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